

SILICON GATE CMOS

65,536 WORD x 4 BIT CMOS STATIC RAM

Description

The TC55465AP/AJ is a 262,144 bit high speed CMOS static random access memory organized as 65,536 words by 4 bits and operated from a single 5V supply. Toshiba's advanced CMOS technology and circuit design enable high speed operation.

The TC55465AP/AJ features low power dissipation when the device is deselected using chip enable ($\overline{CE}$) and has an output enable input ($\overline{OE}$) for fast memory access. Also, the device power between memory accesses is reduced by an automatic power down circuit.

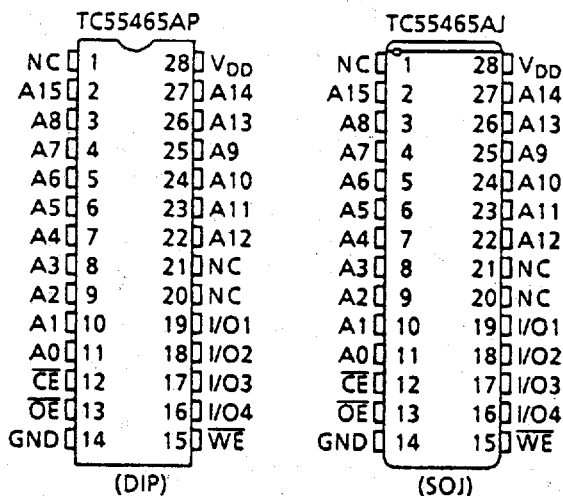
The TC55465AP/AJ is suitable for use in high speed applications such as cache memory and high speed storage. All inputs and outputs are TTL compatible.

The TC55465AP/AJ is available in a 300mil width, 28-pin DIP and SOJ suitable for high density surface assembly.

Features

- Fast access time
 - TC55465AP/AJ-15 15ns (max.)
 - TC55465AP/AJ-20 20ns (max.)
 - TC55465AP/AJ-25 25ns (max.)
 - TC55465AP/AJ-35 35ns (max.)
- Low power dissipation
 - Operation:
 - TC55465AP/AJ-15 120mA (max.)
 - TC55465AP/AJ-20 120mA (max.)
 - TC55465AP/AJ-25 120mA (max.)
 - TC55465AP/AJ-35 100mA (max.)
 - Standby: 1mA (max.)
- Single 5V power supply: 5V $\pm$ 10%
- Fully static operation
- Inputs and outputs TTL compatible
- Output buffer control: $\overline{OE}$
- Package:
 - TC55465AP: DIP28-P-300B
 - TC55465AJ: SOJ28-P-300A

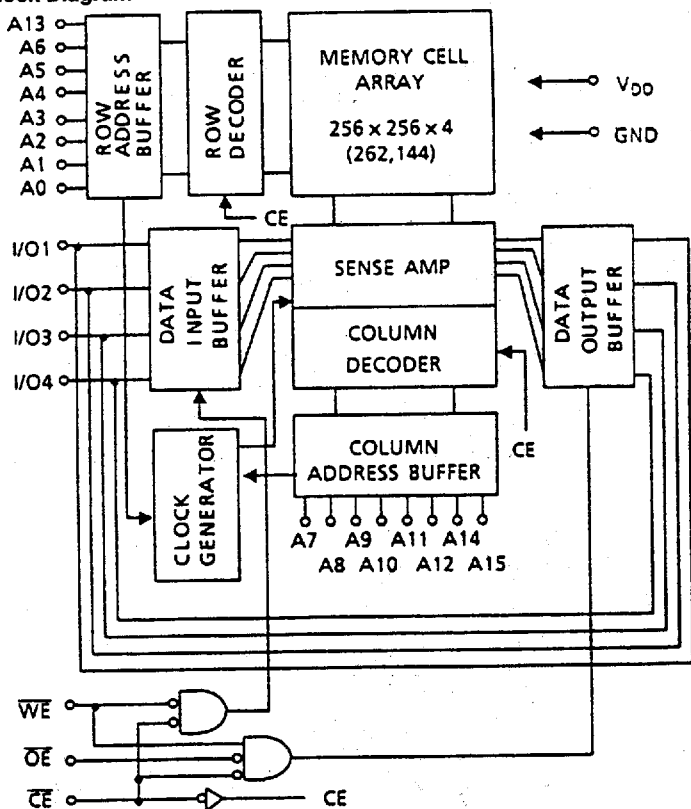
Pin Connection (Top View)



Pin Names

A0 ~ A15	Address Inputs
I/O1 ~ I/O4	Data Inputs/Outputs
$\overline{CE}$	Chip Enable Input
WE	Write Enable Input
$\overline{OE}$	Output Enable Input
V _{DD}	Power (+5V)
GND	Ground
NC	No Connection

Block Diagram



Operating Mode

MODE \ PIN	$\overline{CE}$	$\overline{OE}$	$\overline{WE}$	I/O1 ~ I/O4	POWER
Read	L	L	H	Output	I_{DDO}
Write	L	*	L	Input	I_{DDO}
Output Disable	L	H	H	High Impedance	I_{DDO}
Standby	H	*	*	High Impedance	I_{DPS}

*H or L

Maximum Ratings

SYMBOL	ITEM	RATING	UNIT
V_{DD}	Power Supply Voltage	-0.5 ~ 7.0	V
V_{IN}	Input Voltage	-2.0 ~ 7.0	V
V_{IO}	Input/Output Voltage	-0.5* ~ $V_{DD} + 0.5$	V
P_D	Power Dissipation	1.0	W
T_{SOLDER}	Soldering Temperature • Time	260 • 10	°C • sec
T_{STRG}	Storage Temperature	-65 ~ 150	°C
T_{OPR}	Operating Temperature	-10 ~ 85	°C

* -3V with a pulse width of 10ns

DC Recommended Operating Conditions

SYMBOL	PARAMETER	MIN.	TYP.	MAX.	UNIT
V_{DD}	Power Supply Voltage	4.5	5.0	5.5	V
V_{IH}	Input High Voltage	2.2	—	$V_{DD} + 0.5$	V
V_{IL}	Input Low Voltage	-0.5*	—	0.8	V

* -3V with a pulse width of 10ns

DC Characteristics ($T_a = 0 \sim 70^\circ\text{C}$, $V_{DD} = 5V \pm 10\%$)

SYMBOL	PARAMETER	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
I_{LI}	Input Leakage Current	$V_{IN} = 0 \sim V_{DD}$	—	—	± 1	μA
I_{LO}	Output Leakage Current	$\overline{OE} = V_{IH}$ or $\overline{OE} = V_{IH}$ or $\overline{WE} = V_{IL}$, $V_{OUT} = 0 \sim V_{DD}$	—	—	± 1	μA
I_{OH}	Output High Current	$V_{OH} = 2.4V$	-4	—	—	mA
I_{OL}	Output Low Current	$V_{OL} = 0.4V$	8	—	—	mA
I_{DDO}	Operating Current	$t_{\text{cycle}} = \text{Min cycle}$ $\overline{OE} = V_{IL}$ Other Inputs = V_{IH}/V_{IL}	-15	—	—	mA
			-20	—	—	
			-25	—	—	
			-35	—	—	
I_{DDs1}	Standby Current	$t_{\text{cycle}} = \text{Min cycle}$ $\overline{OE} = V_{IH}$ Other Inputs = V_{IH}/V_{IL}	-15	—	—	mA
			-20			
			-25			
			-35			
I_{DDs2}		$\overline{OE} = V_{DD} - 0.2V$ Other Inputs = $V_{DD} - 0.2V$ or $0.2V$	—	—	1	

Capacitance* ($T_a = 25^\circ\text{C}$, $f = 1.0\text{MHz}$)

SYMBOL	PARAMETER	TEST CONDITION	MAX.	UNIT
C_{IN}	Input Capacitance	$V_{IN} = \text{GND}$	6	pF
$C_{I/O}$	Input/Output Capacitance	$V_{I/O} = \text{GND}$	8	pF

*This parameter is periodically sampled and is not 100% tested.

AC Characteristics ($T_a = 0 \sim 70^\circ\text{C}^{(1)}$, $V_{DD} = 5V \pm 10\%$)

Read Cycle

SYMBOL	PARAMETER	TC55465AP/AJ-15		TC55465AP/AJ-20		TC55465AP/AJ-25		TC55465AP/AJ-35		UNIT
		MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	
t_{RC}	Read Cycle Time	15	—	20	—	25	—	35	—	ns
t_{ACC}	Address Access Time	—	15	—	20	—	25	—	35	
t_{CO}	$\overline{CE}$ Access Time	—	15	—	20	—	25	—	35	
t_{OE}	$\overline{OE}$ Access Time	—	8	—	10	—	12	—	15	
t_{OH}	Output Data Hold Time from Address Change	5	—	5	—	5	—	5	—	
t_{COE}	Output Enable Time from $\overline{CE}$	5	—	5	—	5	—	5	—	
t_{COD}	Output Disable Time from $\overline{OE}$	—	8	—	8	—	10	—	15	
t_{OEE}	Output Enable Time from $\overline{OE}$	1	—	1	—	1	—	1	—	
t_{ODO}	Output Disable Time from $\overline{OE}$	—	8	—	8	—	10	—	15	

Write Cycle

SYMBOL	PARAMETER	TC55465AP/AJ-15		TC55465AP/AJ-20		TC55465AP/AJ-25		TC55465AP/AJ-35		UNIT
		MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	
t_{WC}	Write Cycle Time	15	—	20	—	25	—	35	—	ns
t_{WP}	Write Pulse Width	10	—	11	—	13	—	18	—	
t_{AW}	Address Valid to End of Write	12	—	13	—	15	—	20	—	
t_{CW}	Chip Enable to End of Write	12	—	13	—	15	—	20	—	
t_{AS}	Address Setup Time	0	—	0	—	0	—	0	—	
t_{WR}	Write Recovery Time	0	—	0	—	0	—	0	—	
t_{DS}	Data Setup Time	8	—	10	—	12	—	15	—	
t_{DH}	Data Hold Time	0	—	0	—	0	—	0	—	
t_{OEW}	Output Enable Time from $\overline{WE}$	1	—	1	—	1	—	1	—	
t_{ODW}	Output Disable Time from $\overline{WE}$	—	8	—	8	—	10	—	15	

AC Test Conditions

Input Pulse Levels	3.0V/0.0V
Input Pulse Rise and Fall Time	3ns
Input Timing Measurement Reference Levels	2.2V/0.8V
Output Timing Measurement Reference Levels	2.0V/0.8V
Output Load	Fig. 1

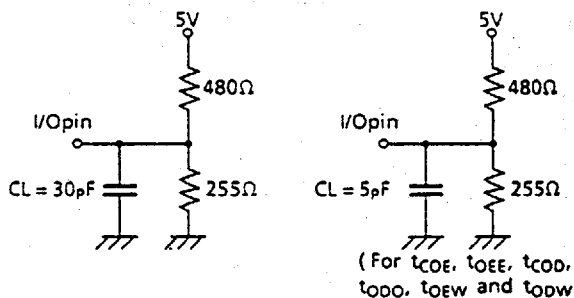
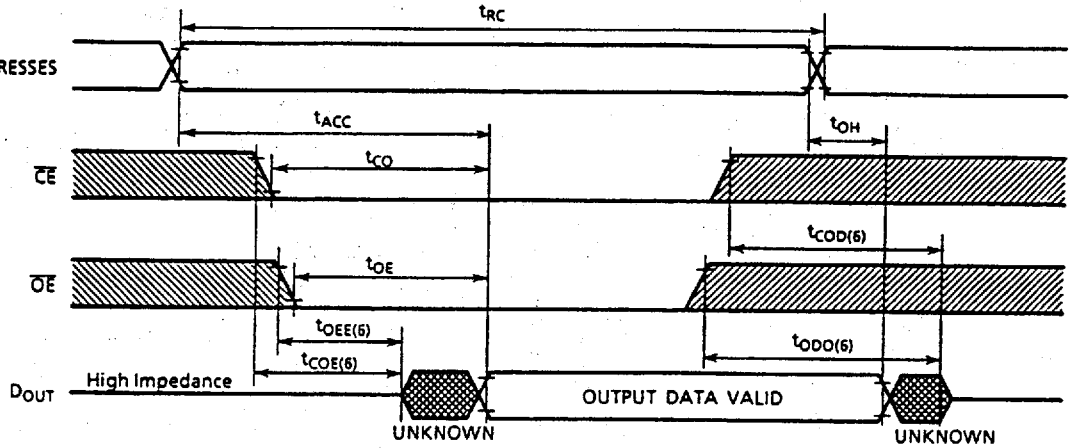
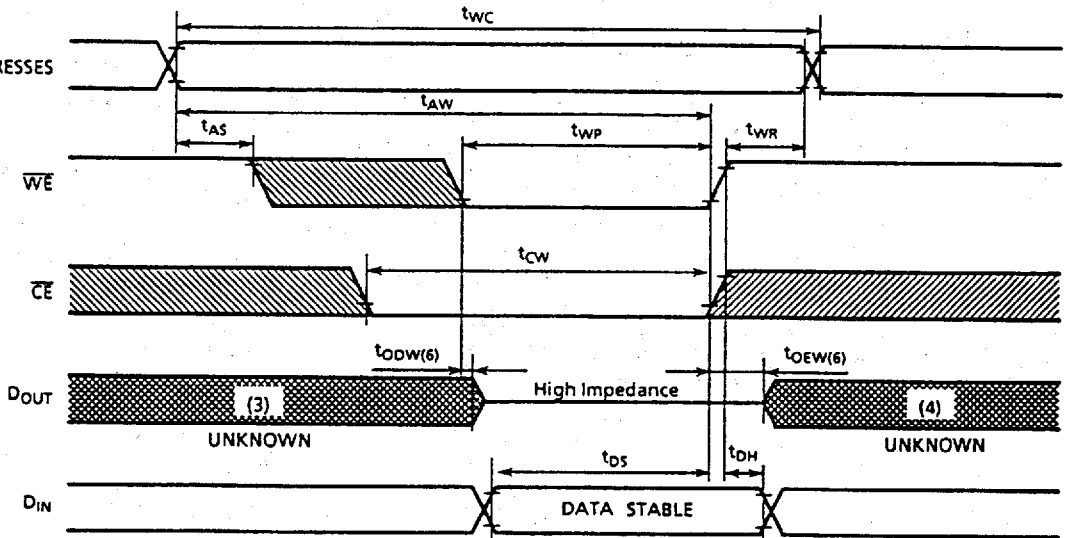
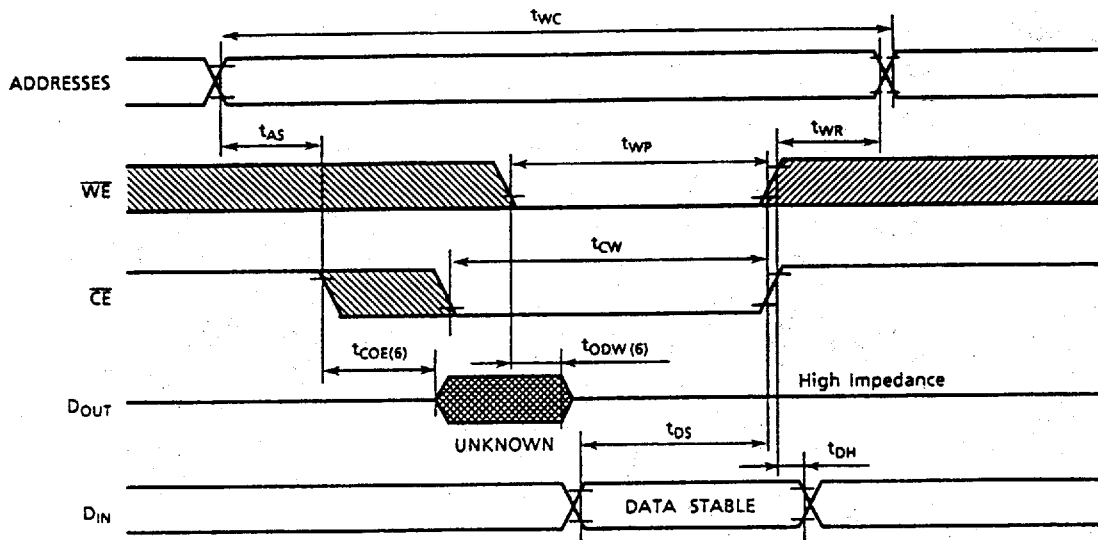


Figure 1.

Timing Waveforms

Read Cycle ⁽²⁾Write Cycle 1 ⁽⁵⁾ ($\overline{WE}$ Controlled Write)

Write Cycle 2⁽⁵⁾ ($\overline{\text{CE}}$ Controlled Write)

Notes:

1. The operating temperature (T_a) is guaranteed with transverse air flow exceeding 400 linear feet per minute.
2. $\overline{WE}$ is high for read cycles.
3. If the $\overline{OE}$ low transition occurs coincident with or after the $\overline{WE}$ low transition, outputs remain in a high impedance state.
4. If the $\overline{OE}$ high transition occurs coincident with or prior to the $\overline{WE}$ high transition, outputs remain in a high impedance state.
5. If $\overline{OE}$ is high during a write cycle, the outputs are in a high impedance state during this period.
6. The following parameters are measured using the load shown in Fig. 1.
 - (A) t_{COE} , t_{OEE} , $t_{OE\overline{W}}$ Output Enable Time
 - (B) t_{COD} , t_{ODO} , $t_{OD\overline{W}}$ Output Disable Time

